

CPC**COOPERATIVE PATENT CLASSIFICATION****H01G**

CAPACITORS; CAPACITORS, RECTIFIERS, DETECTORS, SWITCHING DEVICES OR LIGHT-SENSITIVE DEVICES, OF THE ELECTROLYTIC TYPE (selection of specified materials as dielectric [H01B 3/00](#); { ceramics [C04B](#) })

H01G 2/00

Details of capacitors not covered by a single one of groups [H01G 4/00-H01G 11/00](#)

H01G 2/02

- . Mountings

H01G 2/04

- . . specially adapted for mounting on a chassis

H01G 2/06

- . . specially adapted for mounting on a printed-circuit support

H01G 2/065

- . . . { for surface mounting, e.g. chip capacitors }

H01G 2/08

- . Cooling arrangements; Heating arrangements; Ventilating arrangements

H01G 2/10

- . Housing; Encapsulation { **WARNING: Not complete, see also [H01G 4/224](#)** }

H01G 2/103

- . . { Sealings, e.g. for lead-in wires; Covers }

H01G 2/106

- . . { Fixing the capacitor in a housing }

H01G 2/12

- . Protection against corrosion ([H01G 2/10](#) takes precedence)

H01G 2/14

- . Protection against electric or thermal overload (by cooling [H01G 2/08](#))

H01G 2/16

- . . with fusing elements

H01G 2/18

- . . with breakable contacts

H01G 2/20

- . Arrangements for preventing discharge from edges of electrodes

H01G 2/22

- . Electrostatic or magnetic shielding

H01G 2/24

- . Distinguishing marks, e.g. colour coding

H01G 4/00

Fixed capacitors; Processes of their manufacture (electrolytic capacitors [H01G 9/00](#))

H01G 4/002

- . Details

H01G 4/005

- . . Electrodes

H01G 4/008

- . . . Selection of materials

H01G 4/0085

- { Fried electrodes }

H01G 4/01

- . . . Form of self-supporting electrodes

H01G 4/012

- . . . Form of non-self-supporting electrodes

H01G 4/015

- . . . Special provisions for self-healing

H01G 4/018

- . . Dielectrics

H01G 4/02

- . . . Gas or vapour dielectrics

H01G 4/04

- . . . Liquid dielectrics

H01G 4/06	...	Solid dielectrics
H01G 4/08	Inorganic dielectrics
H01G 4/085	{ Vapour deposited }
H01G 4/10	Metal-oxide dielectrics { (H01G 4/085 takes precedence) }
H01G 4/105	{ Glass dielectric }
H01G 4/12	Ceramic dielectrics { (H01G 4/085 takes precedence; ceramic materials per se C04B 35/00) }
H01G 4/1209	{ characterised by the ceramic dielectric material (H01G 4/1272 , H01G 4/1281 take precedence) }
H01G 4/1218	{ based on titanium oxides or titanates (H01G 4/1245 takes precedence) }
H01G 4/1227	{ based on alkaline earth titanates }
H01G 4/1236	{ based on zirconium oxides or zirconates (H01G 4/1263 takes precedence) }
H01G 4/1245	{ containing also titanates }
H01G 4/1254	{ based on niobium or tungsten, tantalum oxides or niobates, tantalates }
H01G 4/1263	{ containing also zirconium oxides or zirconates }
H01G 4/1272	{ Semiconductive ceramic capacitors }
H01G 4/1281	{ with grain boundary layer }
H01G 4/129	{ containing a glassy phase, e.g. glass ceramic }
H01G 4/14	Organic dielectrics
H01G 4/145	{ vapour deposited }
H01G 4/16	of fibrous material, e.g. paper
H01G 4/18	of synthetic material, e.g. derivatives of cellulose (H01G 4/16 takes precedence)
H01G 4/183	{ Derivatives of cellulose (H01G 4/145 takes precedence) }
H01G 4/186	{ halogenated (H01G 4/145 takes precedence) }
H01G 4/20	...	using combinations of dielectrics from more than one of groups H01G 4/02 to H01G 4/06 (H01G 4/12 takes precedence)
H01G 4/203	{ Fibrous material or synthetic material }
H01G 4/206	{ inorganic and synthetic material }
H01G 4/22	impregnated
H01G 4/221	{ characterised by the composition of the impregnant }
H01G 4/222	{ halogenated }
H01G 4/224	..	Housing; Encapsulation
H01G 4/228	..	Terminals
H01G 4/232	...	electrically connecting two or more layers of a stacked or rolled capacitor
H01G 4/2325	{ characterised by the material of the terminals }
H01G 4/236	...	leading through the housing, i.e. lead-through
H01G 2004/24	[D0608]
H01G 4/242	...	the capacitive element surrounding the terminal
H01G 4/245	Tabs between the layers of a rolled electrode
H01G 4/248	...	the terminals embracing or surrounding the capacitive element, e.g. caps

- [H01G 4/252](#) takes precedence)
- [H01G 4/252](#) . . . the terminals being coated on the capacitive element ([H01G 4/232](#) takes precedence)
 - [H01G 4/255](#) . . Means for correcting the capacitance value
 - [H01G 4/258](#) . . Temperature compensation means
 - [H01G 4/26](#) . Folded capacitors
 - [H01G 4/28](#) . Tubular capacitors
 - [H01G 4/30](#) . Stacked capacitors ([H01G 4/33](#) takes precedence)
 - [H01G 4/302](#) . . { obtained by injection of metal in cavities formed in a ceramic body }
 - [H01G 4/304](#) . . { obtained from a another capacitor }
 - [H01G 4/306](#) . . { made by thin film techniques }
 - [H01G 4/308](#) . . { made by transfer techniques }
 - [H01G 4/32](#) . Wound capacitors
 - [H01G 4/33](#) . Thin- or thick-film capacitors (thin- or thick-film circuits [H01L 27/00](#) { capacitors without a potential-jump or surface barrier specially adapted for integrated circuits, details thereof, multistep manufacturing processes therefor [H01L 28/40](#) })
 - [H01G 4/35](#) . Feed-through capacitors or anti-noise capacitors
 - [H01G 4/38](#) . Multiple capacitors, i.e. structural combinations of fixed capacitors
 - [H01G 4/385](#) . . { Single unit multiple capacitors, e.g. dual capacitor in one coil }
 - [H01G 4/40](#) . Structural combinations of fixed capacitors with other electric elements, the structure mainly consisting of a capacitor, e.g. RC combinations (thin or thick film circuits [H01L 27/00](#); { capacitors without a potential-jump or surface barrier specially adapted for integrated circuits, details thereof, multistep manufacturing processes therefor [H01L 28/40](#) })
 - H01G 5/00** **Capacitors in which the capacitance is varied by mechanical means, e.g. by turning a shaft; Processes of their manufacture**
 - [H01G 5/01](#) . Details
 - [H01G 5/011](#) . . Electrodes
 - [H01G 5/012](#) . . . at least one of the electrodes being a displaceable liquid or powder
 - [H01G 5/013](#) . . Dielectrics
 - [H01G 5/0132](#) . . . { Liquid dielectrics }
 - [H01G 5/0134](#) . . . { Solid dielectrics }
 - [H01G 5/0136](#) { with movable electrodes }
 - [H01G 5/0138](#) { with movable dielectrics }
 - [H01G 5/014](#) . . Housing; Encapsulation
 - [H01G 5/015](#) . . Current collectors
 - [H01G 5/017](#) . . Temperature compensation
 - [H01G 5/019](#) . . Means for correcting the capacitance characteristics

- H01G 2005/02 . IPC5 having air, gas, or vacuum as the dielectric
- H01G 5/04 . using variation of effective area of electrode
- H01G 5/06 . . due to rotation of flat or substantially flat electrodes
- H01G 5/08 . . . becoming active in succession
- H01G 5/10 . . due to rotation of helical electrodes
- H01G 5/12 . . due to rotation of part-cylindrical, conical, or spherical electrodes
- H01G 5/14 . . due to longitudinal movement of electrodes
- H01G 5/145 . . { with profiled electrodes }
- H01G 5/16 . using variation of distance between electrodes
- H01G 5/18 . . due to change in inclination, e.g. by flexing, by spiral wrapping
- H01G 5/38 . Multiple capacitors, e.g. ganged
- H01G 5/40 . Structural combinations of variable capacitors with other electric elements not covered by this subclass, the structure mainly consisting of a capacitor, e.g. RC combinations (RC-filters [H03H](#))
- H01G 7/00** **Capacitors in which the capacitance is varied by non-mechanical means; Processes of their manufacture** (capacitors with potential jump or surface barrier [H01L 29/00](#))
- H01G 7/02 . Electrets, i.e. having a permanently-polarised dielectric
- H01G 7/021 . . { having an organic dielectric }
- H01G 7/023 . . . { of macromolecular compounds }
- H01G 7/025 . . { having an inorganic dielectric }
- H01G 7/026 . . . { with ceramic dielectric }
- H01G 7/028 . . { having a heterogeneous dielectric }
- H01G 7/04 . having a dielectric selected for the variation of its permittivity with applied temperature
- H01G 7/06 . having a dielectric selected for the variation of its permittivity with applied voltage, i.e. ferroelectric capacitors (electrets [H01G 7/02](#))
- H01G 9/00** **Electrolytic capacitors, rectifiers, detectors, switching devices, light-sensitive or temperature-sensitive devices; Processes of their manufacture**
- H01G 9/0003 . { Protection against electric or thermal overload; cooling arrangements; means for avoiding the formation of cathode films ([H01G 9/12](#) takes precedence) }
- H01G 2009/0007 . Double layer capacitors
- H01G 2009/001 . Temperature sensitive devices
- H01G 2009/0014 . Solid electrolytic capacitors
- H01G 2009/0018 . . with wound foil electrodes

- H01G 2009/0021 . . Skin fibre
- H01G 2009/0025 . Liquid electrolytic capacitors
- H01G 9/0029 . { Processes of manufacture }
- H01G 9/0032 . . { formation of the dielectric layer (anodisation in general [C25D](#)) }
- H01G 9/0036 . . { Formation of the solid electrolyte layer }
- H01G 9/004 . Details
- H01G 9/008 . . Terminals
- H01G 9/012 . . . specially adapted for solid capacitors
- H01G 9/016 . . . specially adapted for double-layer capacitors
- H01G 9/02 . . Diaphragms; Separators
- H01G 9/022 . . Electrolytes, absorbents (electrolytic or electrophoretic processes, apparatus therefor [C25](#) ; for primary, secondary or fuel cells [H01M](#))
- H01G 9/025 . . . Solid electrolytes ([H01G 11/54](#) takes precedence)
- H01G 9/028 Organic semiconducting electrolytes, e.g. TCNQ
- H01G 9/032 Inorganic semiconducting electrolytes, e.g. MnO₂
- H01G 9/035 . . . Liquid electrolytes, e.g. impregnating materials ([H01G 11/54](#) takes precedence)
- H01G 9/038 . . . Electrolytes specially adapted for double-layer capacitors

WARNING

This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to group [H01G 11/54](#)

- H01G 9/04 . . Electrodes { or formation of dielectric layers thereon }
- H01G 2009/0404 . . . characterised by the material (alloys in general see [C22C](#))
- H01G 2009/0408 on Al basis
- H01G 2009/0412 . . . characterised by the structure
- H01G 2009/0416 Etched foil electrodes (etching of metal in general [C23F](#) ; electro-etching of metal in general [C25F](#))
- H01G 9/042 . . . characterised by the material ([H01G 11/22](#) takes precedence)
- H01G 9/0425 { specially adapted for cathode }
- H01G 9/045 based on aluminium
- H01G 9/048 . . . characterised by their structure ([H01G 11/22](#) takes precedence)
- H01G 2009/05 . . . IPC5 consisting of tantalum, niobium, or sintered material; Combinations of such electrodes with solid semiconductive electrolytes, e.g. manganese dioxide not used, see subgroups and [H01G 9/00F](#), [H01G 9/04B](#)
- H01G 2009/0503 characterised by the material
- H01G 2009/0506 specially adapted for cathode
- H01G 2009/0509 characterised by the structure
- H01G 2009/0513 sintered
- H01G 2009/0516 Powder therefor (metallic powder in general [B22F](#))
- H01G 9/052 Sintered electrodes

- H01G 9/0525 { Powder therefor (metallic powder in general [B22F](#)) }
- H01G 9/055 Etched foil electrodes
- H01G 9/058 . . . specially adapted for double-layer capacitors

WARNING

This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to group [H01G 11/22](#)

- H01G 9/06 . . . Mounting in containers

WARNING

This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to groups [H01G 11/66](#) - [H01G 11/74](#)

- H01G 9/07 . . Dielectric layers
- H01G 9/08 . . Housing; Encapsulation
- H01G 9/10 . . . Sealing, e.g. of lead-in wires
- H01G 9/12 . . . Vents or other means allowing expansion
- H01G 9/14 . . Structural combinations { or circuits } for modifying, or compensating for, electric characteristics of electrolytic capacitors ([impedance networks H03H](#))

- H01G 9/145 . Liquid electrolytic capacitors ([H01G 11/00](#) takes precedence)

- H01G 9/15 . Solid electrolytic capacitors ([H01G 11/00](#) takes precedence)

- H01G 9/151 . . { with wound foil electrodes }

- H01G 9/153 . . { Skin fibre }

- H01G 9/155 . Double-layer capacitors

WARNING

This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to group [H01G 11/00](#) and its subgroups

- H01G 9/16 . specially for use as rectifiers or detectors ([H01G 9/22](#) takes precedence)

- H01G 9/18 . Self-interrupters

- H01G 9/20 . Light-sensitive devices

- H01G 9/2004 . . { characterised by the electrolyte, e.g. comprising an organic electrolyte }

- H01G 9/2009 . . . { Solid electrolytes }

- H01G 9/2013 . . . { the electrolyte comprising ionic liquids, e.g. alkyl imidazolium iodide }

- H01G 9/2018 . . . { characterised by the ionic charge transport species, e.g. redox shuttles }

- H01G 9/2022 . . { characterized by the counter electrode }

- H01G 9/2027 . . { comprising an oxide semiconductor electrode }

- H01G 9/2031 . . . { comprising titanium oxide, e.g. TiO₂ ([H01G 9/2036](#) takes precedence) }
- H01G 9/2036 . . . { comprising mixed oxides, e.g. ZnO covered TiO₂ particles }
- H01G 9/204 . . . { comprising zinc oxides, e.g. ZnO ([H01G 9/2036](#) takes precedence) }
- H01G 9/2045 . . { comprising a semiconductor electrode comprising elements of the fourth group of the Periodic System (C, Si, Ge, Sn, Pb) with or without impurities, e.g. doping materials }
- H01G 9/205 . . { comprising a semiconductor electrode comprising AIII-BV compounds with or without impurities, e.g. doping materials }
- H01G 9/2054 . . { comprising a semiconductor electrode comprising AII-BVI compounds, e.g. CdTe, CdSe, ZnTe, ZnSe, with or without impurities, e.g. doping materials ([H01G 9/2027](#) takes precedence) }
- H01G 9/2059 . . { comprising an organic dye as the active light absorbing material, e.g. adsorbed on an electrode or dissolved in solution }
- H01G 9/2063 . . . { comprising a mixture of two or more dyes }
- H01G 9/2068 . . { Panels or arrays of photoelectrochemical cells, e.g. photovoltaic modules based on photoelectrochemical cells }
- H01G 9/2072 . . . { comprising two or more photoelectrodes sensible to different parts of the solar spectrum, e.g. tandem cells }
- H01G 9/2077 . . . { Sealing arrangements, e.g. to prevent the leakage of the electrolyte }
- H01G 9/2081 . . . { Serial interconnection of cells }
- H01G 9/2086 . . . { Photoelectrochemical cells in the form of a fiber }
- H01G 9/209 . . { Light trapping arrangements }
- H01G 9/2095 . . { comprising a flexible substrate }
- H01G 9/21 . . Temperature-sensitive devices
- H01G 9/22 . . Devices using combined reduction and oxidation, e.g. redox arrangement or solion
- H01G 9/26 . . Structural combinations of electrolytic capacitors, rectifiers, detectors, switching devices, light-sensitive or temperature-sensitive devices with each other
- H01G 9/28 . . Structural combinations of electrolytic capacitors, rectifiers, detectors, switching devices with other electric components not covered by this subclass

H01G 11/00 **Hybrid capacitors, i.e. capacitors having different positive and negative electrodes; Electric double-layer [EDL] capacitors [EDLCs]; Processes specially adapted for the manufacture thereof or of parts thereof**

NOTE

Group [H01G 11/02](#) takes precedence over groups [H01G 11/04](#) - [H01G 11/14](#)

WARNING

Groups [H01G 11/00](#) to 11/86 correspond to IPC 2013.01. Concordance CPC - IPC 2012.01 for these groups is as follows: - [H01G 11/00](#) : [H01G 9/155](#) - [H01G 11/02](#) : [H01G 9/28](#); - [H01G 11/04](#) - 11/20: [H01G 9/155](#); - [H01G 11/22](#) - 11/50: [H01G 9/058](#); - [H01G 11/52](#) : [H01G 9/155](#); - [H01G 11/54](#) - 11/64 : [H01G 9/038](#); - [H01G 11/66](#) - 11/76 : [H01G 9/016](#); - [H01G 11/78](#) - 11/84 : [H01G 9/155](#); - [H01G 11/86](#) : [H01G 9/058](#)

- H01G 11/02 . using combined reduction-oxidation reactions, e.g. redox arrangement or solion
- H01G 11/04 . Hybrid capacitors
- H01G 11/06 . . with one of the electrodes allowing ions or anions to be reversibly doped thereinto, e.g. lithium-ion capacitors [LICs]
- H01G 11/08 . Structural combinations, e.g. assembly or connection, of hybrid or EDL capacitors with other electric components, at least one hybrid or EDL capacitor being the main component
- H01G 11/10 . Multiple hybrid or EDL capacitors, e.g. arrays or modules ([housings, cases or mountings thereof H01G 11/78](#))
- H01G 11/12 . . Stacked hybrid or EDL capacitors
- H01G 11/14 . Arrangements or processes for adjusting or protecting hybrid or EDL capacitors ([emergency protective circuit arrangements specially adapted for capacitors, and effecting automatic switching in the event of an undesired change from normal working conditions H02H 7/16; emergency protective circuit arrangements for limiting excess current or voltages without disconnection H02H 9/00](#))
- H01G 11/16 . . against electric overloads, e.g. including fuses
- H01G 11/18 . . against thermal overloads, e.g. heating, cooling or ventilating
- H01G 11/20 . . Reformation or processes for removal of impurities, e.g. scavenging
- H01G 11/22 . Electrodes
- H01G 11/24 . . characterised by structural features, e.g. forms, shapes, surface areas, porosities or dimensions, of the materials making up or comprised in the electrodes; characterised by the structural features of powders or particles used therefor
- H01G 11/26 . . characterised by the structures of the electrodes, e.g. multi-layered, shapes, dimensions, porosities or surface features
- H01G 11/28 arranged or disposed on a current collector; Layers or phases between electrodes and current collectors, e.g. adhesives
- H01G 11/30 . . characterised by their materials
- H01G 11/32 Carbon-based, e.g. activated carbon materials
- H01G 11/34 characterised by carbonisation or activation of carbon
- H01G 11/36 Nanostructures, e.g. nanofibres, nanotubes or fullerenes
- H01G 11/38 Carbon pastes or blends; Binders or additives therein
- H01G 11/40 Fibres
- H01G 11/42 Powders or particles, e.g. composition thereof
- H01G 11/44 Raw materials therefor, e.g. resins or coal
- H01G 11/46 Metal oxides, e.g. ruthenium oxide
- H01G 11/48 Conductive polymers
- H01G 11/50 specially adapted for lithium-ion capacitors, e.g. for lithium-doping or for intercalation
- H01G 11/52 . Separators
- H01G 11/54 . Electrolytes
- H01G 11/56 . . Solid electrolytes, e.g. gel; Additives therein

- H01G 11/58 . . Liquid electrolytes
- H01G 11/60 . . . characterised by the solvent
- H01G 11/62 . . . characterised by the solute, e.g. salts, anions or cations therein
- H01G 11/64 . . . characterised by additives

- H01G 11/66 . Current collectors
- H01G 11/68 . . characterised by their materials
- H01G 11/70 . . characterised by their structures
- H01G 11/72 . . specially adapted for integration in multiple or stacked hybrid or EDL capacitors

- H01G 11/74 . Terminals, e.g. extensions of current collectors
- H01G 11/76 . . specially adapted for integration in multiple or stacked hybrid or EDL capacitors

- H01G 11/78 . Cases; Housings; Encapsulations; Mountings
- H01G 11/80 . . Gaskets; Sealings
- H01G 11/82 . . Fixing or assembling a capacitive element in a housing, e.g. mounting electrodes, current collectors or terminals in containers or encapsulations

- H01G 11/84 . Processes for the manufacture of hybrid or EDL capacitors, or components thereof
- H01G 11/86 . . specially adapted for electrodes ([carbonization or activation of carbon for the manufacture of electrodes H01G 11/34](#))

- H01G 13/00** **Apparatus specially adapted for manufacturing capacitors; Processes specially adapted for manufacturing capacitors not provided for in groups [H01G 4/00](#) to [H01G 11/00](#)**

- H01G 13/003 . { [Apparatus or processes for encapsulating capacitors](#) }
- H01G 13/006 . { [Apparatus or processes for applying terminals](#) }
- H01G 13/02 . Machines for winding capacitors ([winding in general B65H](#))
- H01G 13/04 . Drying ([in general F26B](#)); Impregnating
- H01G 13/06 . with provision of removing metal surfaces

- H01G 15/00** **Structural combinations of capacitors or other devices covered by at least two different main groups of this subclass with each other ([involving at least one hybrid or electric double-layer \[EDL\] capacitor as main component H01G 11/08](#))**

- H01G 17/00** **Structural combinations of capacitors or other devices covered by at least two different main groups of this subclass with other electric elements, not covered by this subclass, e.g. RC combinations ([thin- or thick-film circuits H01L 27/00](#); RC-filters [H03H](#))**